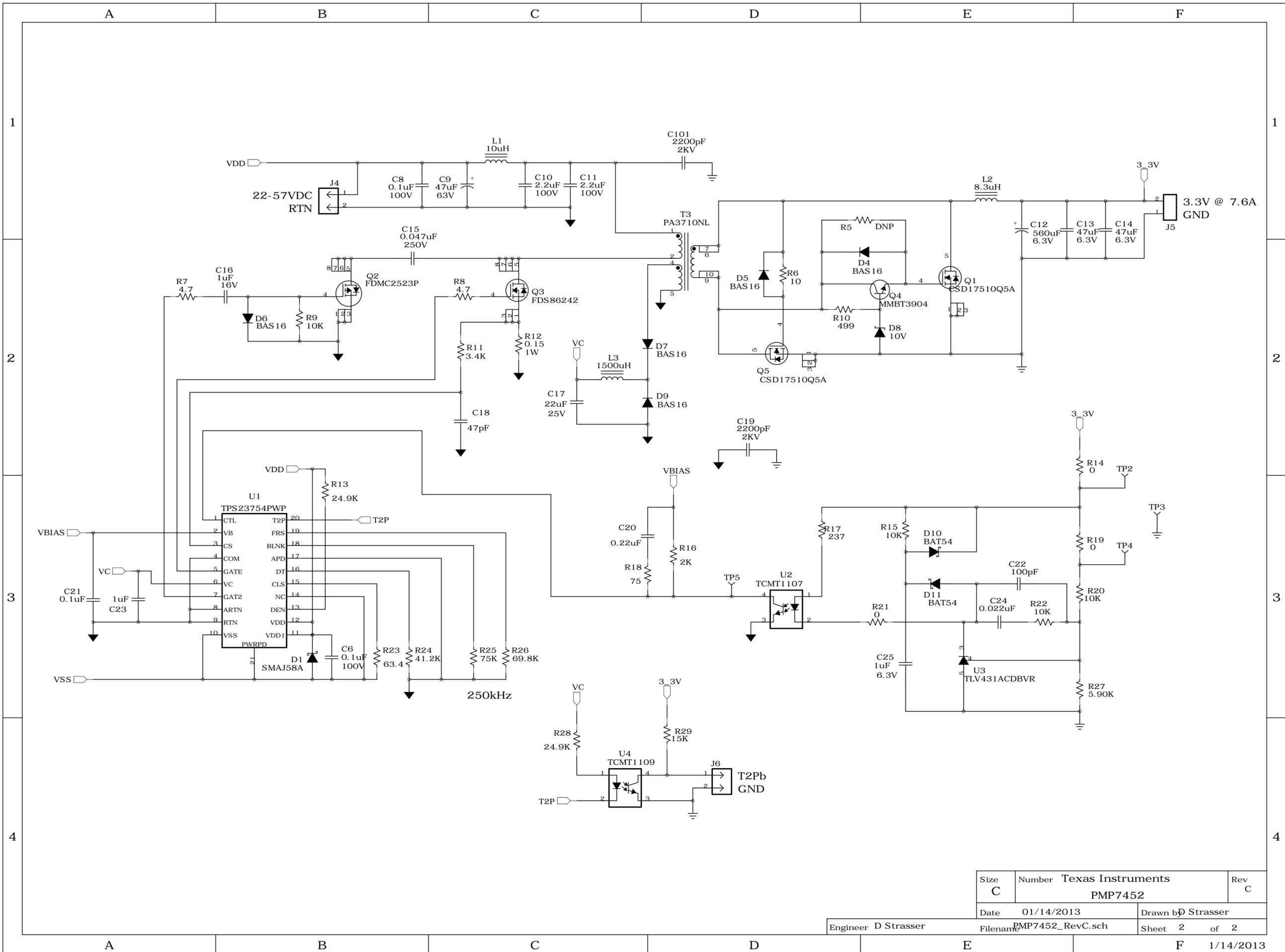


Build on PMP5818 Rev B PCB
 C12, L1, L2, L3, Q2, R12 require modifications

Title			
High Power PoE			
Size	Number	Company	Rev
C	PMP7452	Texas Instruments	C
Date	01/14/2013	Drawn by	Strasser
Filename	PMP7452_RevC.sch	Sheet	1 of 2

Engineer D Strasser

1/14/2013



Size C	Number Texas Instruments	Rev C
PMP7452		
Date 01/14/2013	Drawn by D Strasser	
Engineer D Strasser	Filename PMP7452_RevC.sch	Sheet 2 of 2

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